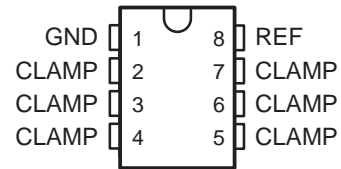


# TL7726 HEX CLAMPING CIRCUITS

SLAS078C – SEPTEMBER 1993 – REVISED JULY 1999

- Protects Against Latch-Up
- 25-mA Current Sink in Active State
- Less Than 1-mW Dissipation in Standby Condition
- Ideal for Applications in Environments Where Large Transient Spikes Occur
- Stable Operation for All Values of Capacitive Load
- No Output Overshoot

D OR P PACKAGE  
(TOP VIEW)



## description

The TL7726 consists of six identical clamping circuits that monitor an input voltage with respect to a reference value, REF. For an input voltage ( $V_I$ ) in the range of GND to  $< REF$ , the clamping circuits present a very high impedance to ground, drawing current of less than 10  $\mu A$ . The clamping circuits are active for  $V_I < GND$  or  $V_I > REF$  when they have a very low impedance and can sink up to 25 mA.

These characteristics make the TL7726 ideal as protection devices for CMOS semiconductor devices in environments where there are large positive or negative transients to protect analog-to-digital converters in automotive or industrial systems. The use of clamping circuits provides a safeguard against potential latch-up.

The TL7726C is characterized for operation over the temperature range of 0°C to 70°C. The TL7726I is characterized for operation over the temperature range of -40°C to 85°C. The TL7726Q is characterized for operation over the temperature range of -40°C to 125°C.

### AVAILABLE OPTIONS

| $T_A$          | SOIC (D) | PLASTIC DIP (P) |
|----------------|----------|-----------------|
| 0°C to 70°C    | TL7726CD | TL7726CP        |
| -40°C to 85°C  | TL7726ID | TL7726IP        |
| -40°C to 125°C | TL7726QD | TL7726QP        |

The D package is available taped and reeled. Add the suffix R to the device type (i.e., TL7726CDR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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# TL7726

## HEX CLAMPING CIRCUITS

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### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

|   |                |
|---|----------------|
| Reference voltage, $V_{ref}$  | 6 V            |
| Clamping current, $I_{IK}$  | $\pm 50$ mA    |
| Junction temperature, $T_J$   | 150°C          |
| Package thermal impedance, $\theta_{JA}$ (see Notes 1 and 2): D package | 97°C/W         |
| P package   | 127°C/W        |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds            | 260°C          |
| Storage temperature range, $T_{stg}$                                    | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
2. The package thermal impedance is calculated in accordance with JEESD 51, except for through-hole packages, which use a trace length of zero.

### recommended operating conditions

|   | MIN                | MAX | UNIT |
|---|--------------------|-----|------|
| Reference voltage, $V_{ref}$                | 4.5                | 5.5 | V    |
| Input clamping current, $I_{IK}$            | $V_I \geq V_{ref}$ | 25  | mA   |
|   | $V_I \leq GND$     | -25 |      |
| Operating free-air temperature range, $T_A$ | TL7726C            | 0   | °C   |
|   | TL7726I            | -40 |      |
|   | TL7726Q            | -40 |      |

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                        | TEST CONDITIONS                           | MIN       | TYP‡ | MAX             | UNIT    |
|----------------------------------|---|-----------|------|-----------------|---------|
| $V_{IK+}$ Positive clamp voltage | $I_I = 20$ mA                             | $V_{ref}$ |      | $V_{ref} + 200$ | mV      |
| $V_{IK-}$ Negative clamp voltage | $I_I = 20$ mA                             | -200      |      | 0               | mV      |
| $I_Z$ Reference current          | $V_{ref} = 5$ V                           |           | 25   | 60              | $\mu$ A |
| $I_I$ Input current              | $V_{ref} - 50$ mV $\leq V_I \leq V_{ref}$ |           |      | 10              | $\mu$ A |
|                                  | $GND \leq V_I \leq 50$ mV                 |           | -10  |                 |         |
|                                  | $50$ mV $\leq V_I \leq V_{ref} - 50$ mV   |           | -1   | 1               |         |

‡ All typical values are at  $T_A = 25^\circ\text{C}$ .

### switching characteristics specified at $T_A = 25^\circ\text{C}$

| PARAMETER           | TEST CONDITIONS  | MIN | MAX | UNIT          |
|---------------------|--|-----|-----|---------------|
| $t_s$ Settling time | $V_I(system) = \pm 13$ V, $R_I = 600 \Omega$ , $t_t < 1 \mu\text{s}$ ,<br>Measured at 10% to 90%, See Figure 1 |     | 30  | $\mu\text{s}$ |

PARAMETER MEASUREMENT INFORMATION

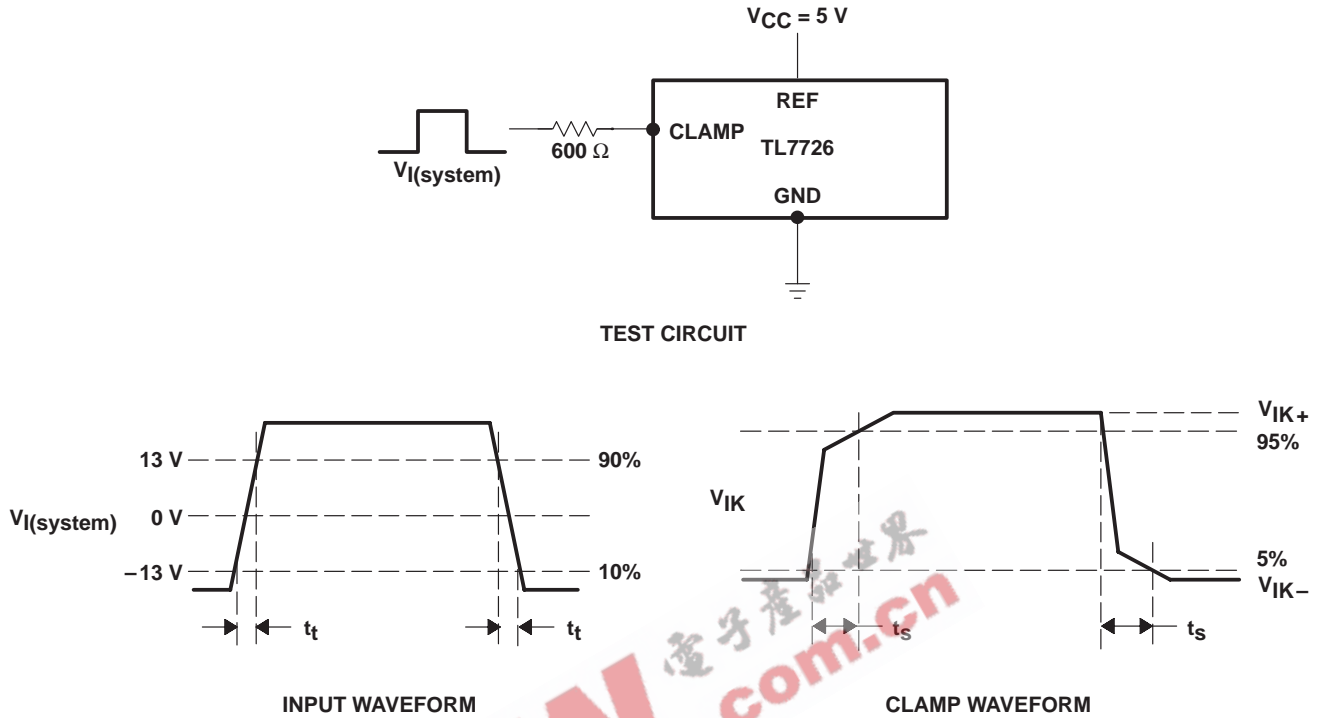


Figure 1. Switching Characteristics

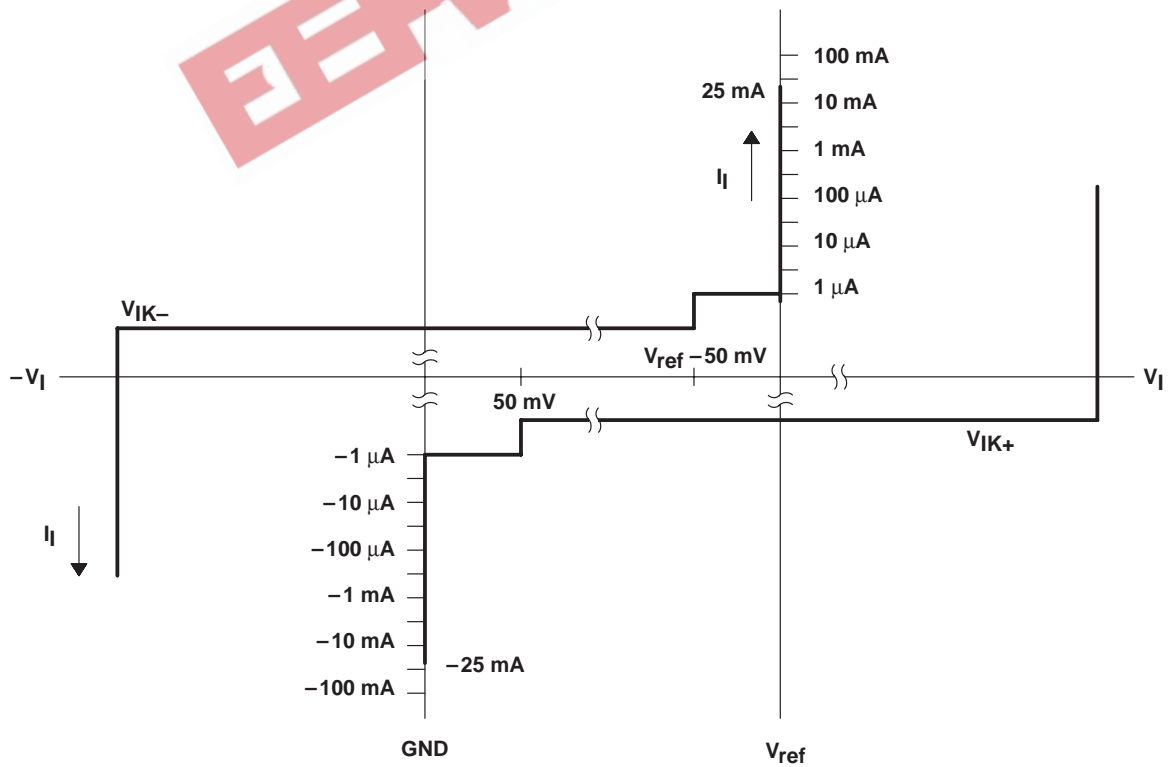
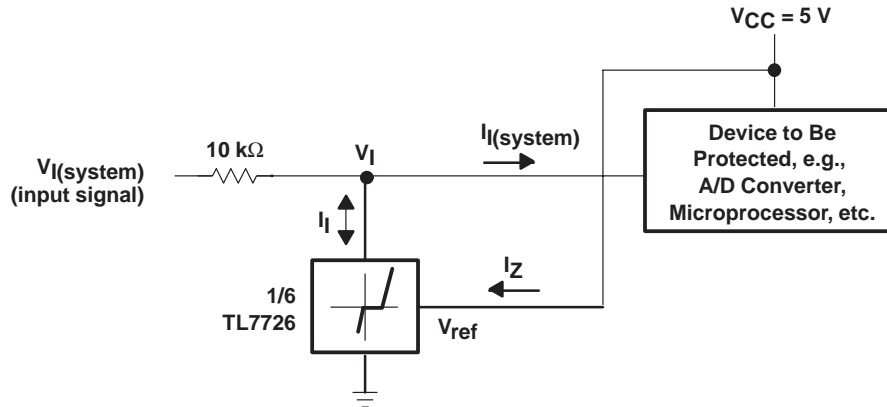


Figure 2. Tolerance Band for Clamping Circuit

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## APPLICATION INFORMATION



Example: If  $I_i \gg I_{i(\text{system})}$ , i.e.,  $V_{I(\text{system})} > V_{\text{ref}} + 200\text{ mV}$   
where:

$I_{i(\text{system})}$  = Input current to the device being protected

$V_{I(\text{system})}$  = Input voltage to the device being protected

then the maximum input voltage

$$\begin{aligned} V_{I(\text{system})\text{max}} &= V_{\text{ref}} + I_{i\text{max}}(10\text{ k}\Omega) \\ &= 5\text{ V} + 25\text{ mA}(10\text{ k}\Omega) \\ &= 5\text{ V} + 250\text{ V} \\ &= 255\text{ V} \end{aligned}$$

Figure 3. Typical Application

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